

## TRANSMITTAL LETTER

(General Patent Pending)

Docket No.

H2.003D2

In Re Application Of:

Takashi Ohsumi

Serial No.

09/920,713

Filing Date

August 3, 2001

Examiner

Fernand Toled

Group Art Unit

2823

Title: A METHOD FOR FABRICATING A SEMICONDUCTOR APPARATUS INCLUDING A SEALING  
MEMBER WITH REDUCED THERMAL STRESS (As Amended)

TO THE COMMISSIONER FOR PATENTS:

Transmitted herewith is:

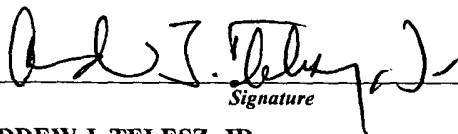
Request for Reconsideration

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in the above identified application.

- ☒ No additional fee is required.
- ☐ A check in the amount of \_\_\_\_\_ is attached.
- ☒ The Director is hereby authorized to charge and credit Deposit Account No. \_\_\_\_\_ as described below.
- ☐ Charge the amount of \_\_\_\_\_
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50-0238

  
Signature

Dated: July 17, 2003

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